

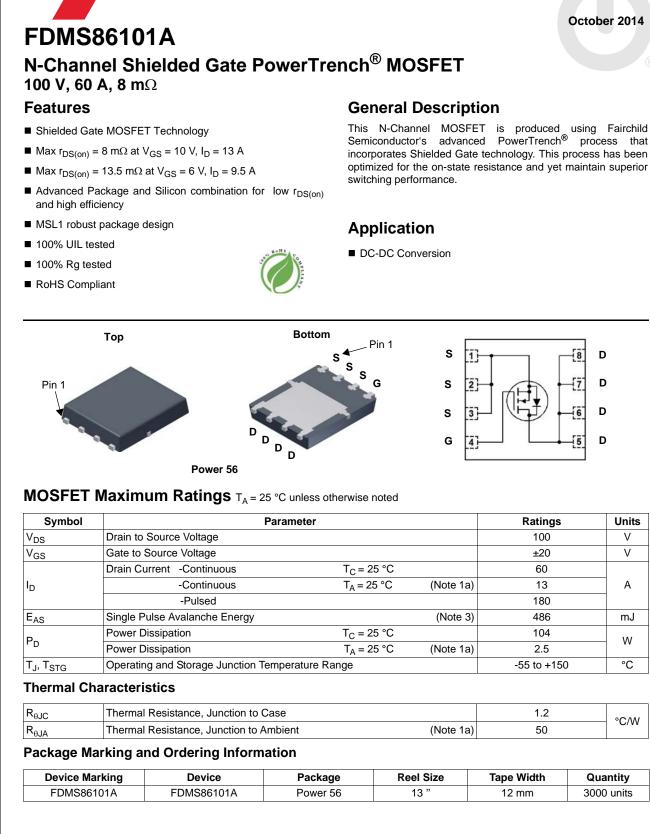
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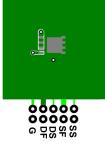


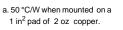
FDMS86101A N-Channel Shielded Gate PowerTrench[®] MOSFET

FAIRCHILD

| FDMS86101A N-Channel Shielded Gate PowerTrench [®] | |
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| elded Gate | |
| PowerTre | |
| nch [®] MOSFET |) |
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| Symbol | Parameter | Test Conditions | Min | Тур | Max | Units |
|--|---|---|-----|-------------------|-------------------|----------------|
| Off Chara | cteristics | | | | | I |
| BV _{DSS} | Drain to Source Breakdown Voltage | I _D = 250 μA, V _{GS} = 0 V | 100 | | | V |
| $\frac{\Delta BV_{DSS}}{\Delta T_J}$ | Breakdown Voltage Temperature Coefficient | $I_D = 250 \ \mu$ A, referenced to 25 °C | | 71 | | mV/°C |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} = 80 V, V _{GS} = 0 V | | | 800 | nA |
| I _{GSS} | Gate to Source Leakage Current | $V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$ | | | ±100 | nA |
| | cteristics | | | 1 | 1 | 1 |
| V _{GS(th)} | Gate to Source Threshold Voltage | V _{GS} = V _{DS} , I _D = 250 μA | 2.0 | 3.1 | 4.0 | V |
| $\frac{\Delta V_{GS(th)}}{\Delta T_{I}}$ | Gate to Source Threshold Voltage Temperature Coefficient | $I_D = 250 \ \mu$ A, referenced to 25 °C | | -9 | | mV/°C |
| 5 | | V _{GS} = 10 V, I _D = 13 A | | 6.3 | 8 | |
| r _{DS(on)} | Static Drain to Source On Resistance | $V_{GS} = 6 \text{ V}, \text{ I}_{D} = 9.5 \text{ A}$ | | 8.0 | 13.5 | mΩ |
| 20(01) | | $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$ | | 10.3 | 13.1 | |
| 9 _{FS} | Forward Transconductance | V _{DS} = 10 V, I _D = 13 A | | 53 | | S |
| C _{iss} C _{oss} C _{rss} | Input Capacitance Output Capacitance Reverse Transfer Capacitance | $V_{DS} = 50 V, V_{GS} = 0 V,$ f = 1 MHz | | 3095 460 15 | 4120 615 25 | pF pF pF |
| | | f = 1 MHz | | | | |
| R _g | Gate Resistance | | 0.1 | 1.6 | 3.3 | Ω |
| Switching | Characteristics | | | [] | | 1 |
| t _{d(on)} | Turn-On Delay Time | | | 19 | 35 | ns |
| t _r | Rise Time | V_{DD} = 50 V, I _D = 13 A, V _{GS} = 10 V, R _{GEN} = 6 Ω | | 5.4 | 11 | ns |
| t _{d(off)} | Turn-Off Delay Time | | | 27 | 44 | ns |
| t _f | Fall Time | | | 4 | 10 | ns |
| Qg | Total Gate Charge | $V_{GS} = 0 V$ to 10 V | | 42 | 58 | nC |
| Qg | Total Gate Charge | $V_{GS} = 0 V \text{ to } 5 V V_{DD} = 50 V,$ | | 22 | 31 | nC |
| Q _{gs} | Gate to Source Charge | I _D = 13 A | | 13.5 | | nC |
| Q _{gd} | Gate to Drain "Miller" Charge | | | 6.2 | | nC |
| Drain-Soເ | urce Diode Characteristics | | | | | |
| V _{SD} | Source to Drain Diode Forward Voltage | $V_{GS} = 0 V, I_S = 2.1 A$ (Note 2) | | 0.74 | 1.2 | v |
| 50 | | $V_{GS} = 0 V, I_S = 13 A$ (Note 2) | | 0.81 | 1.3 | |
| t _{rr} | Reverse Recovery Time | I _F = 13 A, di/dt = 100 A/μs | | 64 | 102 | ns |
| Q _{rr} | Reverse Recovery Charge | F, | | 102 | 164 | nC |





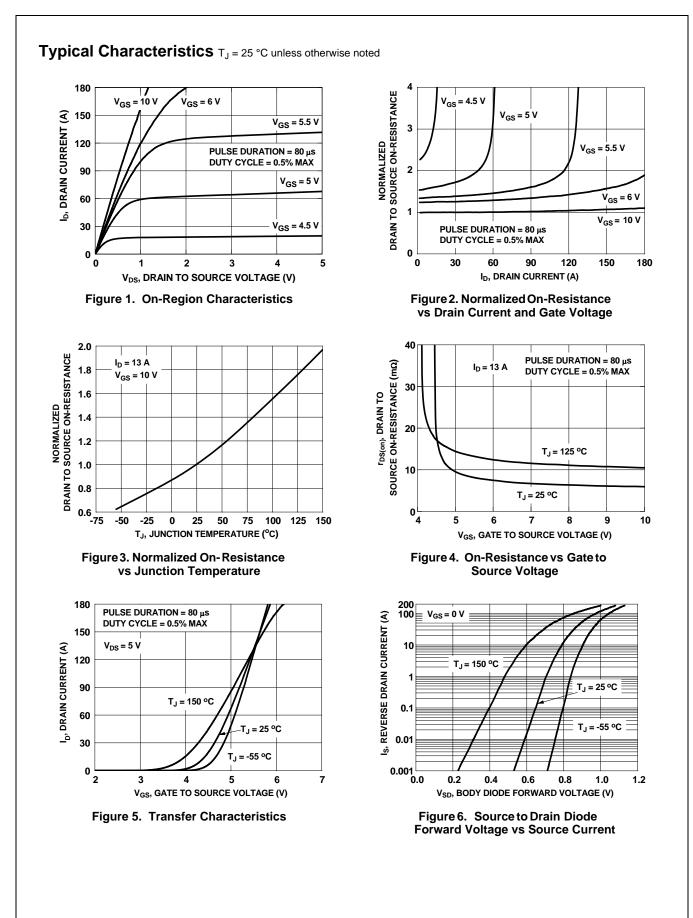


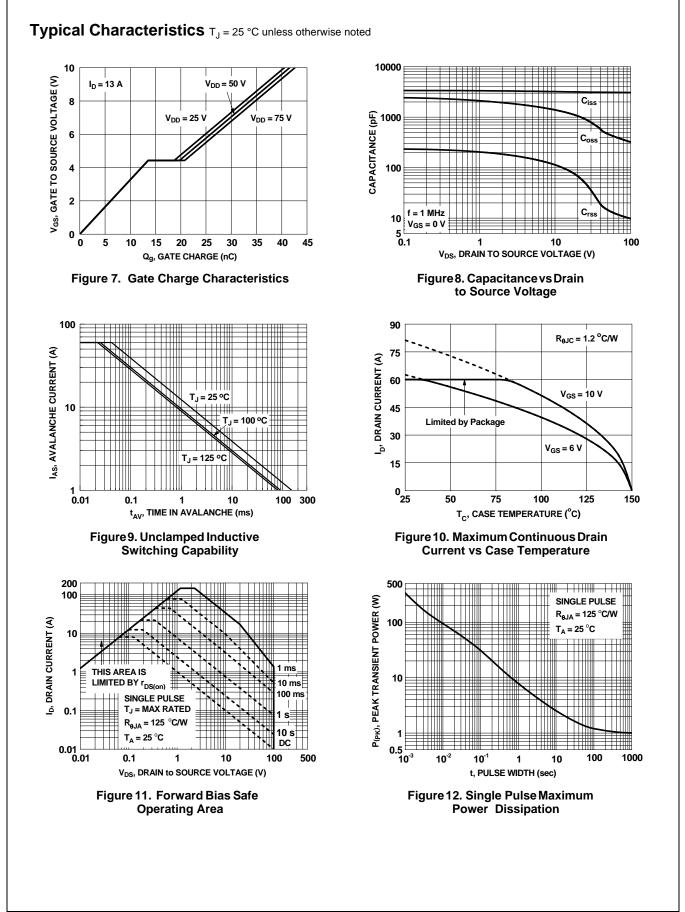
b. 125 °C/W when mounted on a minimum pad of 2 oz copper.

2. Pulse Test: Pulse Width < 300 $\mu \text{s},$ Duty cycle < 2.0%.

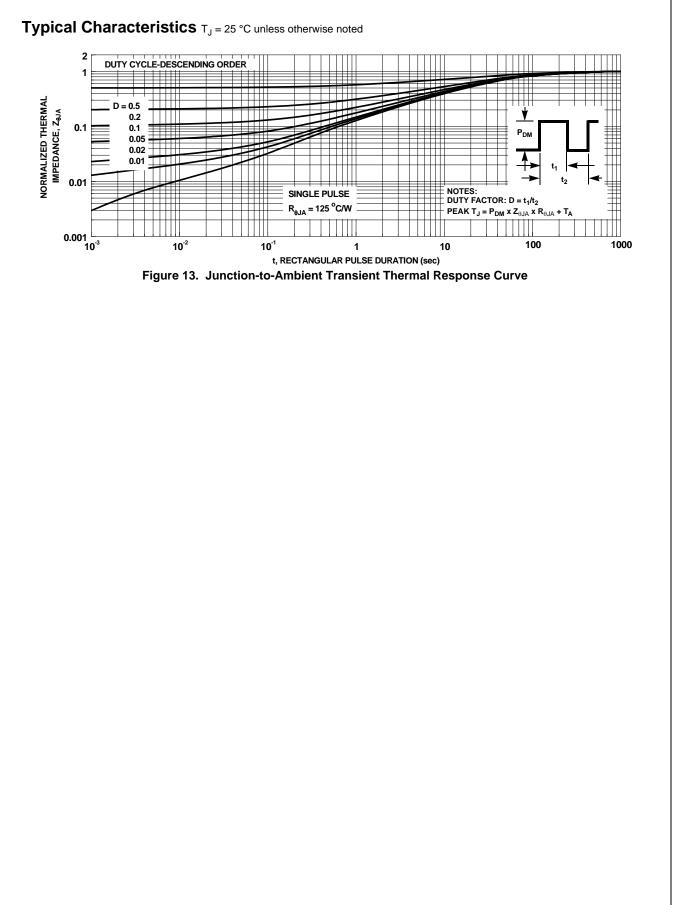
3. E_{AS} 486 mJ is based on starting T_J = 25 °C, L = 3 mH, I_{AS} = 18 A, V_{DD} = 100 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 51 A.







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